# **Dual General Purpose Transistors**

The MBT3904DW1 and MBT3904DW2 devices are a spin-off of our popular SOT-23/SOT-323 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-363 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

#### **Features**

- h<sub>FE</sub>, 100-300
- Low  $V_{CE(sat)}$ ,  $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7-inch/3,000 Unit Tape and Reel
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **MAXIMUM RATINGS**

| Rating                         | Symbol         | Value                     | Unit |
|--------------------------------|----------------|---------------------------|------|
| Collector - Emitter Voltage    | $V_{CEO}$      | 40                        | Vdc  |
| Collector - Base Voltage       | $V_{CBO}$      | 60                        | Vdc  |
| Emitter – Base Voltage         | $V_{EBO}$      | 6.0                       | Vdc  |
| Collector Current – Continuous | I <sub>C</sub> | 200                       | mAdc |
| Electrostatic Discharge        | ESD            | HBM Class 2<br>MM Class B |      |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS

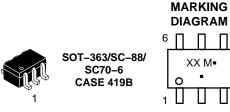
| Characteristic                                   | Symbol                            | Max         | Unit |
|--|-----------------------------------|-------------|------|
| Total Package Dissipation (Note 1) $T_A = 25$ °C | P <sub>D</sub>                    | 150         | mW   |
| Thermal Resistance, Junction–to–Ambient          | $R_{\theta JA}$                   | 833         | °C/W |
| Junction and Storage<br>Temperature Range        | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C   |

<sup>1.</sup> Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



### ON Semiconductor®

www.onsemi.com

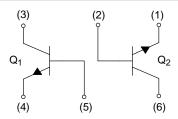


XX=MA for MBT3904DW1T1G MJ for MBT3904DW2T1G

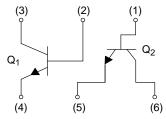
M = Date Code

■ = Pb-Free Package

(Note: Microdot may be in either location)



MBT3904DW1T1 STYLE 1



MBT3904DW2T1 STYLE 27

### ORDERING INFORMATION

| Device                          | Package              | Shipping <sup>†</sup>  |
|---------------------------------|----------------------|------------------------|
| MBT3904DW1T1G,<br>MBT3904DW2T1G | SOT-363<br>(Pb-Free) | 3000 /<br>Tape & Reel  |
| SMBT3904DW1T1G                  | SOT-363<br>(Pb-Free) | 3000 /<br>Tape & Reel  |
| NSVMBT3904DW1T3G                | SOT-363<br>(Pb-Free) | 10000 /<br>Tape & Reel |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

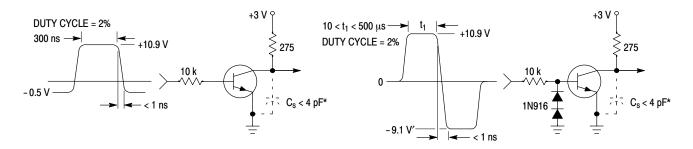
## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

| Characteristic   | Symbol               | Min                         | Max                | Unit               |
|--|----------------------|-----------------------------|--------------------|--------------------|
| OFF CHARACTERISTICS  |                      |                             | -                  | -                  |
| Collector – Emitter Breakdown Voltage (Note 2) $(I_C = 1.0 \text{ mAdc}, I_B = 0)$   | V <sub>(BR)CEO</sub> | 40                          | _                  | Vdc                |
| Collector – Base Breakdown Voltage ( $I_C = 10 \mu Adc$ , $I_E = 0$ )  | V <sub>(BR)CBO</sub> | 60                          | -                  | Vdc                |
| Emitter – Base Breakdown Voltage ( $I_E = 10 \mu Adc$ , $I_C = 0$ )  | V <sub>(BR)EBO</sub> | 6.0                         | _                  | Vdc                |
| Base Cutoff Current<br>(V <sub>CE</sub> = 30 Vdc, V <sub>EB</sub> = 3.0 Vdc)   | I <sub>BL</sub>      | -                           | 50                 | nAdc               |
| Collector Cutoff Current<br>(V <sub>CE</sub> = 30 Vdc, V <sub>EB</sub> = 3.0 Vdc)  | I <sub>CEX</sub>     | -                           | 50                 | nAdc               |
| ON CHARACTERISTICS (Note 2)  |                      |                             |                    |                    |
| DC Current Gain $ \begin{aligned} &(I_C = 0.1 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 1.0 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 10 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 50 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \\ &(I_C = 100 \text{ mAdc, } V_{CE} = 1.0 \text{ Vdc)} \end{aligned} $ | h <sub>FE</sub>      | 40<br>70<br>100<br>60<br>30 | -<br>300<br>-<br>- | -                  |
| Collector – Emitter Saturation Voltage ( $I_C = 10 \text{ mAdc}$ , $I_B = 1.0 \text{ mAdc}$ ) ( $I_C = 50 \text{ mAdc}$ , $I_B = 5.0 \text{ mAdc}$ )   | V <sub>CE(sat)</sub> | -<br>-                      | 0.2<br>0.3         | Vdc                |
| Base – Emitter Saturation Voltage<br>( $I_C = 10 \text{ mAdc}$ , $I_B = 1.0 \text{ mAdc}$ )<br>( $I_C = 50 \text{ mAdc}$ , $I_B = 5.0 \text{ mAdc}$ )  | V <sub>BE(sat)</sub> | 0.65                        | 0.85<br>0.95       | Vdc                |
| SMALL-SIGNAL CHARACTERISTICS   |                      |                             |                    |                    |
| Current – Gain – Bandwidth Product<br>(I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 20 Vdc, f = 100 MHz)  | f <sub>T</sub>       | 300                         | _                  | MHz                |
| Output Capacitance $(V_{CB} = 5.0 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$  | C <sub>obo</sub>     | -                           | 4.0                | pF                 |
| Input Capacitance ( $V_{EB} = 0.5 \text{ Vdc}$ , $I_{C} = 0$ , $f = 1.0 \text{ MHz}$ )   | C <sub>ibo</sub>     | -                           | 8.0                | pF                 |
| Input Impedance ( $V_{CE} = 10 \text{ Vdc}$ , $I_{C} = 1.0 \text{ mAdc}$ , $f = 1.0 \text{ kHz}$ )   | h <sub>ie</sub>      | 1.0<br>2.0                  | 10<br>12           | kΩ                 |
| Voltage Feedback Ratio $(V_{CE} = 10 \text{ Vdc}, I_{C} = 1.0 \text{ mAdc}, f = 1.0 \text{ kHz})$  | h <sub>re</sub>      | 0.5<br>0.1                  | 8.0<br>10          | X 10 <sup>-4</sup> |
| Small – Signal Current Gain<br>(V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz)  | h <sub>fe</sub>      | 100<br>100                  | 400<br>400         | _                  |
| Output Admittance<br>(V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 1.0 mAdc, f = 1.0 kHz)  | h <sub>oe</sub>      | 1.0<br>3.0                  | 40<br>60           | μmhos              |
| Noise Figure ( $V_{CE}$ = 5.0 Vdc, $I_{C}$ = 100 $\mu$ Adc, $R_{S}$ = 1.0 k $\Omega$ , f = 1.0 kHz)  | NF                   | _                           | 5.0                | dB                 |

Pulse Test: Pulse Width ≤ 300 μs; Duty Cycle ≤ 2.0%.

## **SWITCHING CHARACTERISTICS**

| Characteristic |   | Symbol         | Min | Max | Unit |
|----------------|---|----------------|-----|-----|------|
| Delay Time     | $(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc})$ | t <sub>d</sub> | -   | 35  | ns   |
| Rise Time      | (I <sub>C</sub> = 10 mAdc, I <sub>B1</sub> = 1.0 mAdc)  | t <sub>r</sub> | -   | 35  | 115  |
| Storage Time   | (V <sub>CC</sub> = 3.0 Vdc, I <sub>C</sub> = 10 mAdc)   | t <sub>s</sub> | -   | 200 |      |
| Fall Time      | $(I_{B1} = I_{B2} = 1.0 \text{ mAdc})$                  | t <sub>f</sub> | _   | 50  | ns   |

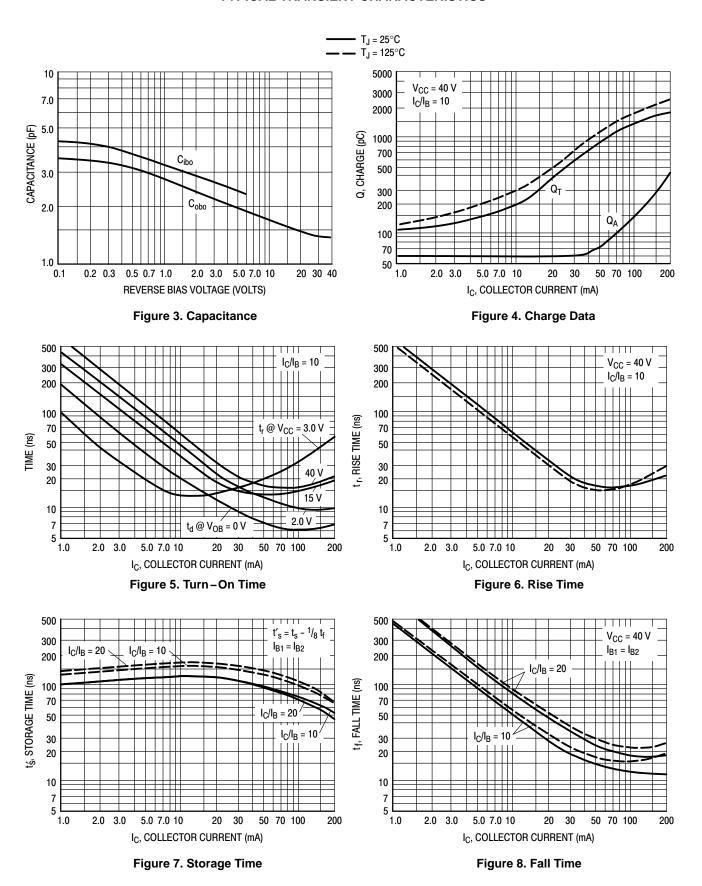


<sup>\*</sup> Total shunt capacitance of test jig and connectors

Figure 1. Delay and Rise Time Equivalent Test Circuit

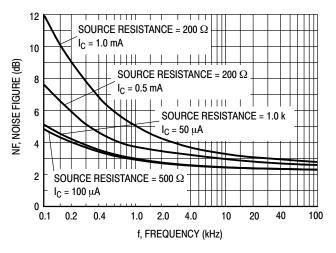
Figure 2. Storage and Fall Time Equivalent Test Circuit

### TYPICAL TRANSIENT CHARACTERISTICS



# TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, Bandwidth = 1.0 \text{ Hz})$ 



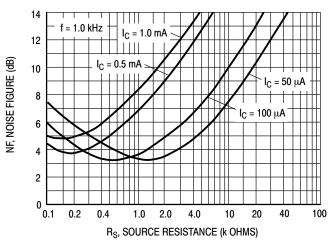
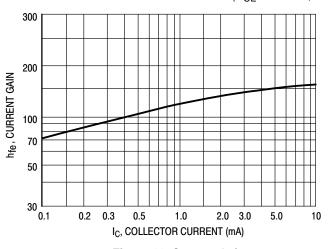


Figure 9. Noise Figure

Figure 10. Noise Figure

### h PARAMETERS

 $(V_{CE}=10~Vdc,\,f=1.0~kHz,\,T_{A}=25^{\circ}C)$ 



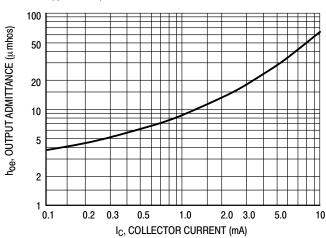


Figure 11. Current Gain

Figure 12. Output Admittance

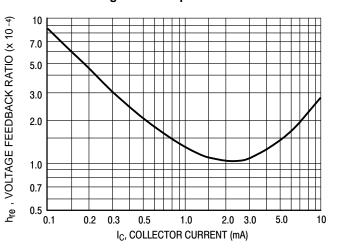


Figure 13. Input Impedance

IC, COLLECTOR CURRENT (mA)

Figure 14. Voltage Feedback Ratio

### TYPICAL STATIC CHARACTERISTICS

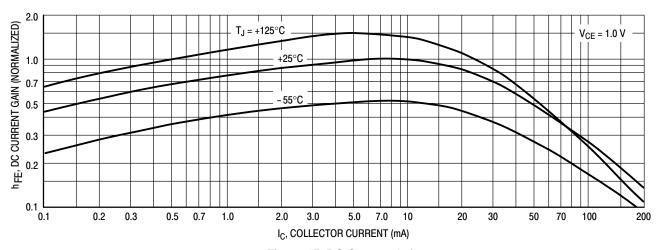


Figure 15. DC Current Gain

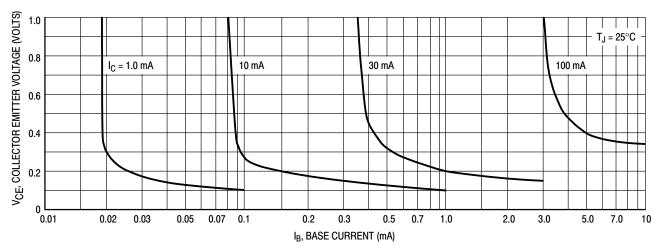


Figure 16. Collector Saturation Region

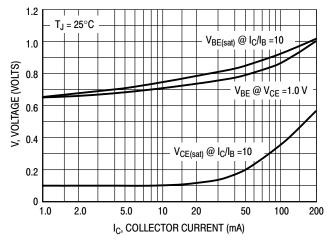
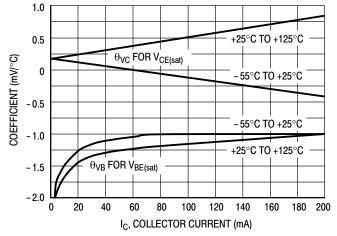


Figure 17. "ON" Voltages



**Figure 18. Temperature Coefficients** 

## **TYPICAL STATIC CHARACTERISTICS**

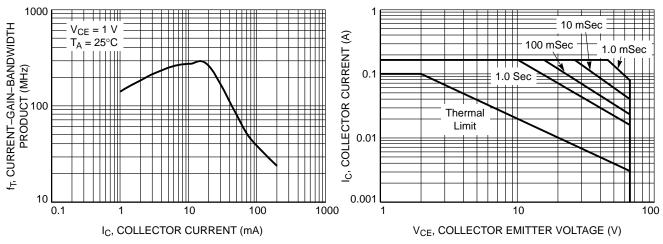


Figure 19. Current Gain Bandwidth Product

Figure 20. Safe Operating Area





E1

6X 0.30 -

e

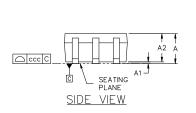
В

### SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 **ISSUE Z**

**DATE 18 APR 2024** 

#### NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- ALL DIMENSION ARE IN MILLIMETERS.
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
- DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
  DATUMS A AND B ARE DETERMINED AT DATUM H.
- DIMENSIONS 6 AND C APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP. 6.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.



TOP VIEW

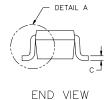
∆aaa H A−B

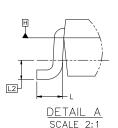
<u></u> БЬБ С

⊕ ddd M C A−B D

6X 0.66

2.50





|     | MILLIMETERS |          |      |  |
|-----|-------------|----------|------|--|
| DIM | MIN.        | NOM.     | MAX. |  |
| Α   |             |          | 1.10 |  |
| A1  | 0.00        |          | 0.10 |  |
| A2  | 0.70        | 0.90     | 1.00 |  |
| b   | 0.15        | 0.20     | 0.25 |  |
| С   | 0.08        | 0.15     | 0.22 |  |
| D   | 2.00 BSC    |          |      |  |
| E   | 2.10 BSC    |          |      |  |
| E1  | 1.25 BSC    |          |      |  |
| е   |             | 0.65 BSC | ;    |  |
| L   | 0.26        | 0.36     | 0.46 |  |
| L2  | 0.15 BSC    |          |      |  |
| aaa | 0.15        |          |      |  |
| bbb | 0.30        |          |      |  |
| ccc | 0.10        |          |      |  |
| ddd | 0.10        |          |      |  |

# **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location)

- \*Date Code orientation and/or position may vary depending upon manufacturing location.
- \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

# RECOMMENDED MOUNTING FOOTPRINT\*

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

### **STYLES ON PAGE 2**

| DOCUMENT NUMBER: | PRASB42985B Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |                             |  |
|------------------|--|-----------------------------|--|
| DESCRIPTION:     | SC-88 2.00x1.25x0.90, 0.65   | SC-88 2.00x1.25x0.90, 0.65P |  |

onsemi and ONSEMi, are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or quarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

### SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 ISSUE Z

**DATE 18 APR 2024** 

| STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | STYLE 2:<br>CANCELLED  | STYLE 3:<br>CANCELLED   | STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE                                 | STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE                                 | STYLE 6:<br>PIN 1. ANODE 2<br>2. N/C<br>3. CATHODE 1<br>4. ANODE 1<br>5. N/C<br>6. CATHODE 2       |
|--|--|---|---|---|--|
| STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2           | STYLE 8:<br>CANCELLED  | STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2  | STYLE 10:<br>PIN 1. SOURCE 2<br>2. SOURCE 1<br>3. GATE 1<br>4. DRAIN 1<br>5. DRAIN 2<br>6. GATE 2           | STYLE 11:<br>PIN 1. CATHODE 2<br>2. CATHODE 2<br>3. ANODE 1<br>4. CATHODE 1<br>5. CATHODE 1<br>6. ANODE 2 | STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2                |
| STYLE 13: PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE                 | STYLE 14:<br>PIN 1. VREF<br>2. GND<br>3. GND<br>4. IOUT<br>5. VEN<br>6. VCC          | STYLE 15: PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1     | STYLE 16:<br>PIN 1. BASE 1<br>2. EMITTER 2<br>3. COLLECTOR 2<br>4. BASE 2<br>5. EMITTER 1<br>6. COLLECTOR 1 | STYLE 17: PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1                 | STYLE 18:<br>PIN 1. VIN1<br>2. VCC<br>3. VOUT2<br>4. VIN2<br>5. GND<br>6. VOUT1                    |
| STYLE 19:<br>PIN 1. I OUT<br>2. GND<br>3. GND<br>4. V CC<br>5. V EN<br>6. V REF          | STYLE 20: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR | STYLE 21: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1               | STYLE 22:<br>PIN 1. D1 (i)<br>2. GND<br>3. D2 (i)<br>4. D2 (c)<br>5. VBUS<br>6. D1 (c)                      | STYLE 23:<br>PIN 1. Vn<br>2. CH1<br>3. Vp<br>4. N/C<br>5. CH2<br>6. N/C                                   | STYLE 24: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE                      |
| STYLE 25: PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1    | STYLE 26: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1      | STYLE 27: PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2 | STYLE 28: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN   | STYLE 29: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE                          | STYLE 30:<br>PIN 1. SOURCE 1<br>2. DRAIN 2<br>3. DRAIN 2<br>4. SOURCE 2<br>5. GATE 1<br>6. DRAIN 1 |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

| DOCUMENT NUMBER: | 98ASB42985B Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |  |             |
|------------------|--|--|-------------|
| DESCRIPTION:     | SC-88 2.00x1.25x0.90, 0.65P  |  | PAGE 2 OF 2 |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales